

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT				
NATURE OF CONVEYANCE:	ASSIGNMENT				
CONVEYING PARTY DATA					
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Satoshi HAYASHI</td> <td>06/25/2013</td> </tr> </tbody> </table>		Name	Execution Date	Satoshi HAYASHI	06/25/2013
Name	Execution Date				
Satoshi HAYASHI	06/25/2013				
RECEIVING PARTY DATA					
Name:	Sekisui Chemical Co., Ltd.				
Street Address:	4-4, Nishitemma 2-chome, Kita-ku				
Internal Address:	Osaka-shi				
City:	Osaka				
State/Country:	JAPAN				
Postal Code:	5300047				
PROPERTY NUMBERS Total: 1					
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13993808</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13993808
Property Type	Number				
Application Number:	13993808				
CORRESPONDENCE DATA					
Fax Number:	2027218250				
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>					
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ATTORNEY DOCKET NUMBER:	2013-0731A				
NAME OF SUBMITTER:	Claudia Siu Orellana				
Signature:	/Claudia Siu Orellana/				
Date:	07/08/2013				
Total Attachments: 2 source=Assignment#page1.tif source=Assignment#page2.tif					

OP \$40.00 13993808

ASSIGNMENT

In consideration of good and valuable consideration paid to each of the undersigned

Insert Name(s) Satoshi HAYASHI
of _____
Inventor(s) _____

Insert Name(s) the undersigned hereby sell(s) and assign(s) to
of Sekisui Chemical Co., Ltd.
Assignee(s) of 4-4, Nishitemma 2-chome, Kita-ku, Osaka-shi, Osaka 5300047 Japan
Address _____

Title of (hereinafter designated as the Assignee) the entire right, title and interest for the
Invention United States as defined in 35 USC 100, in the invention known as
PRODUCTION METHOD FOR POLYAMIDE ACID PARTICLES, PRODUCTION METHOD FOR POLYIMIDE PARTICLES, POLYIMIDE PARTICLES AND BONDING MATERIAL FOR ELECTRONIC COMPONENT

The undersigned agree(s) to execute all papers necessary in connection with this application for patent in the USPTO for the invention, and any continuation, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any post-grant proceeding which may occur in connection with this application or continuation, divisional or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such post-grant proceeding.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements, which includes the right to claim priority and the right to be granted a patent in any PCT Contracting State.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the USPTO to issue any and all Letters Patents of the United States resulting from said application or any continuation, divisional or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and covenant(s) that the undersigned have not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of Wenderoth Lind & Ponack, L.L.P., the power to insert on this document any further identification which may be necessary or desirable.

Executed by the undersigned on the date(s) opposite the undersigned name(s).

Satoshi HAYASHI

JUN. 25. 2013

Satoshi HAYASHI

(Date)

The above application may be more particularly identified as follows:

U.S. Application Serial No.:
Applicant Reference Number: SK896US

Filing Date:
Attorney Docket No.: 2013-0731A